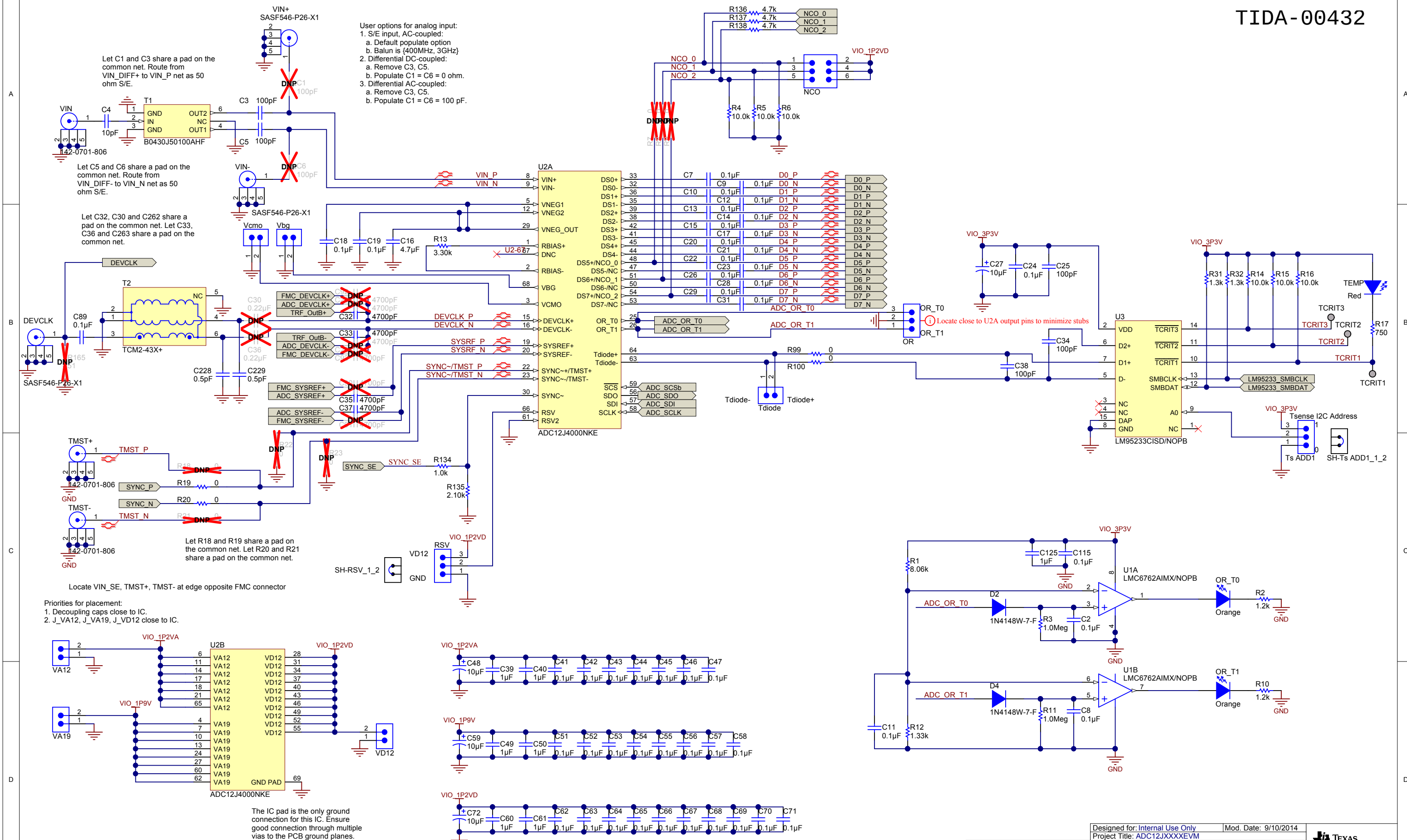
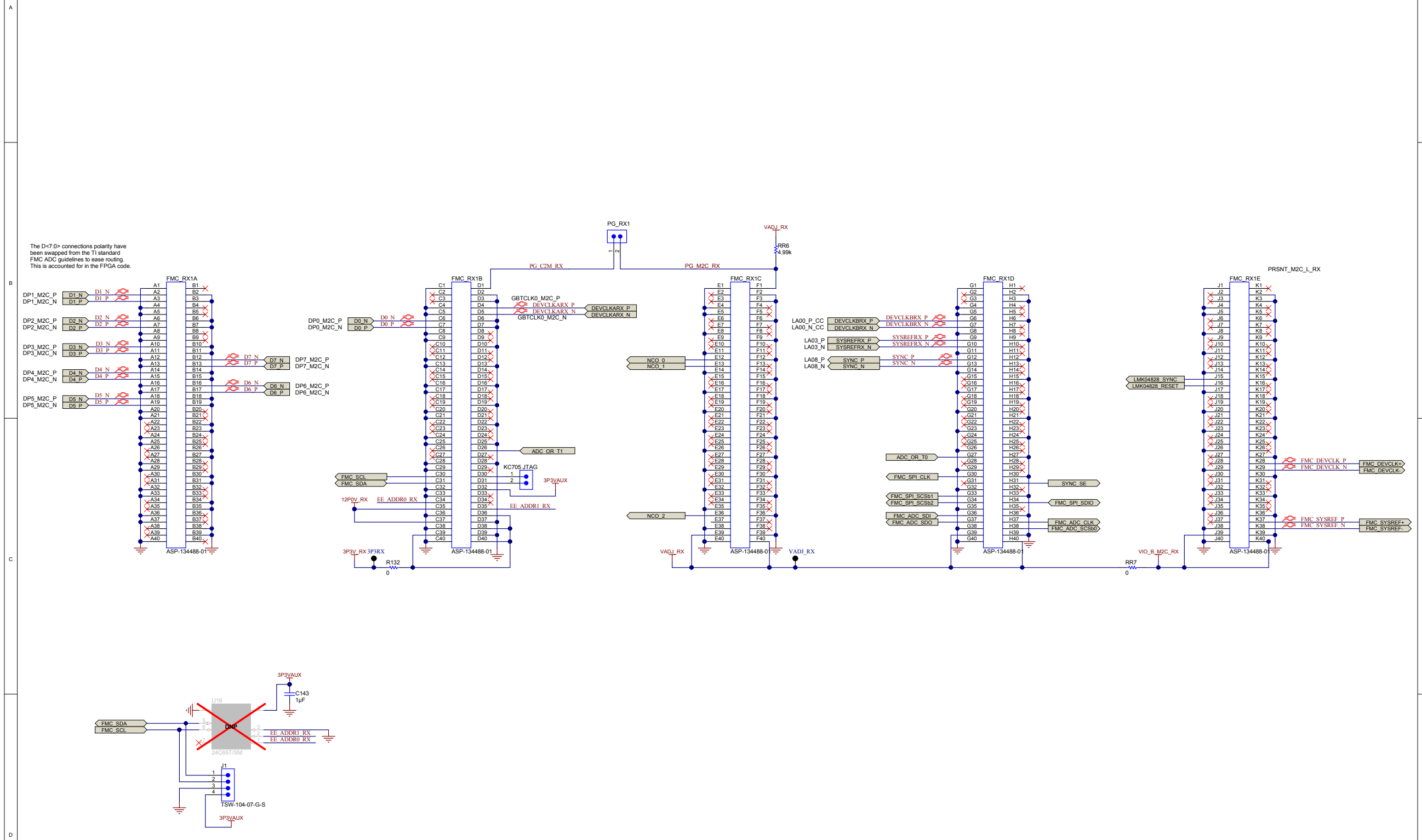


TIDA-00432





A

B

C

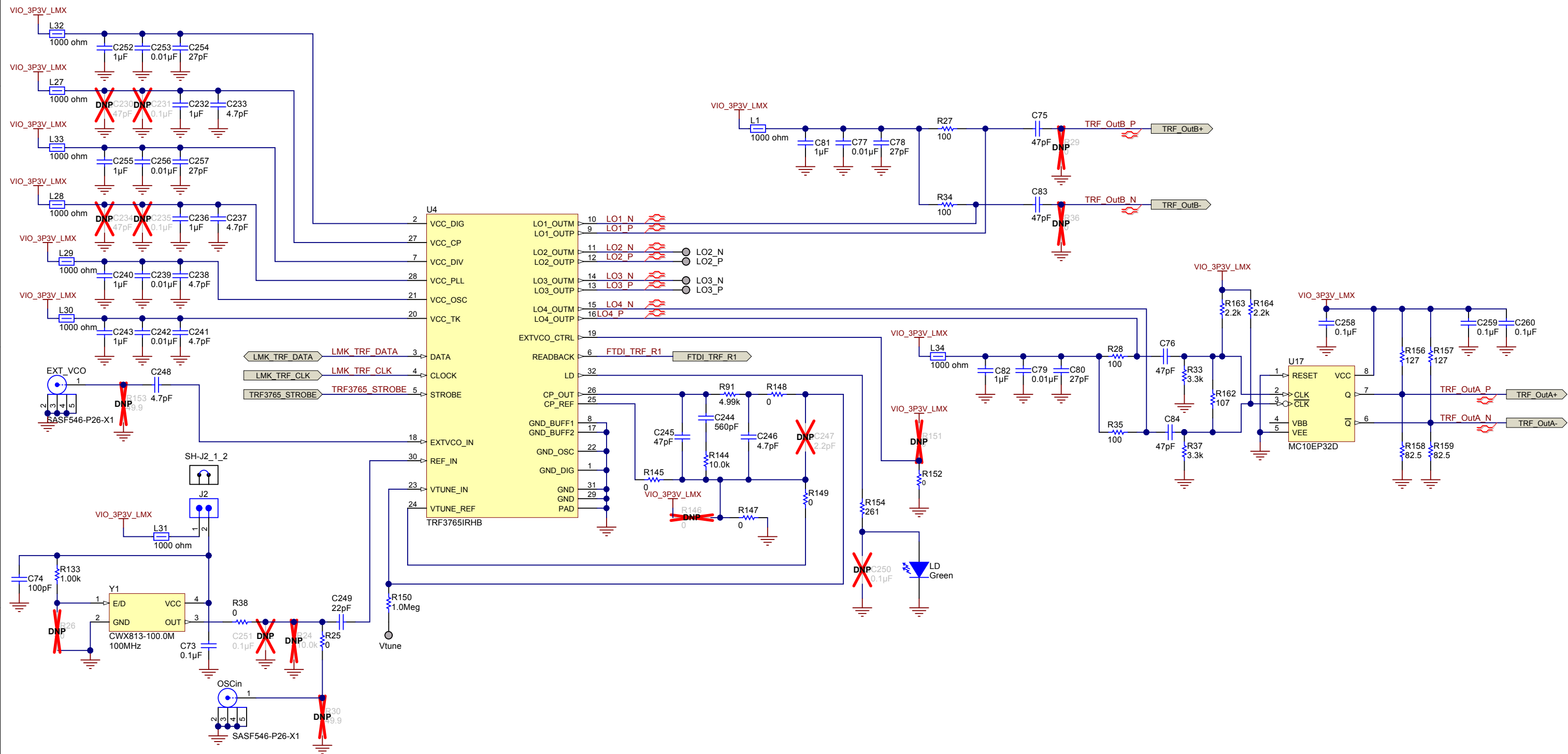
D

A

B

C

D

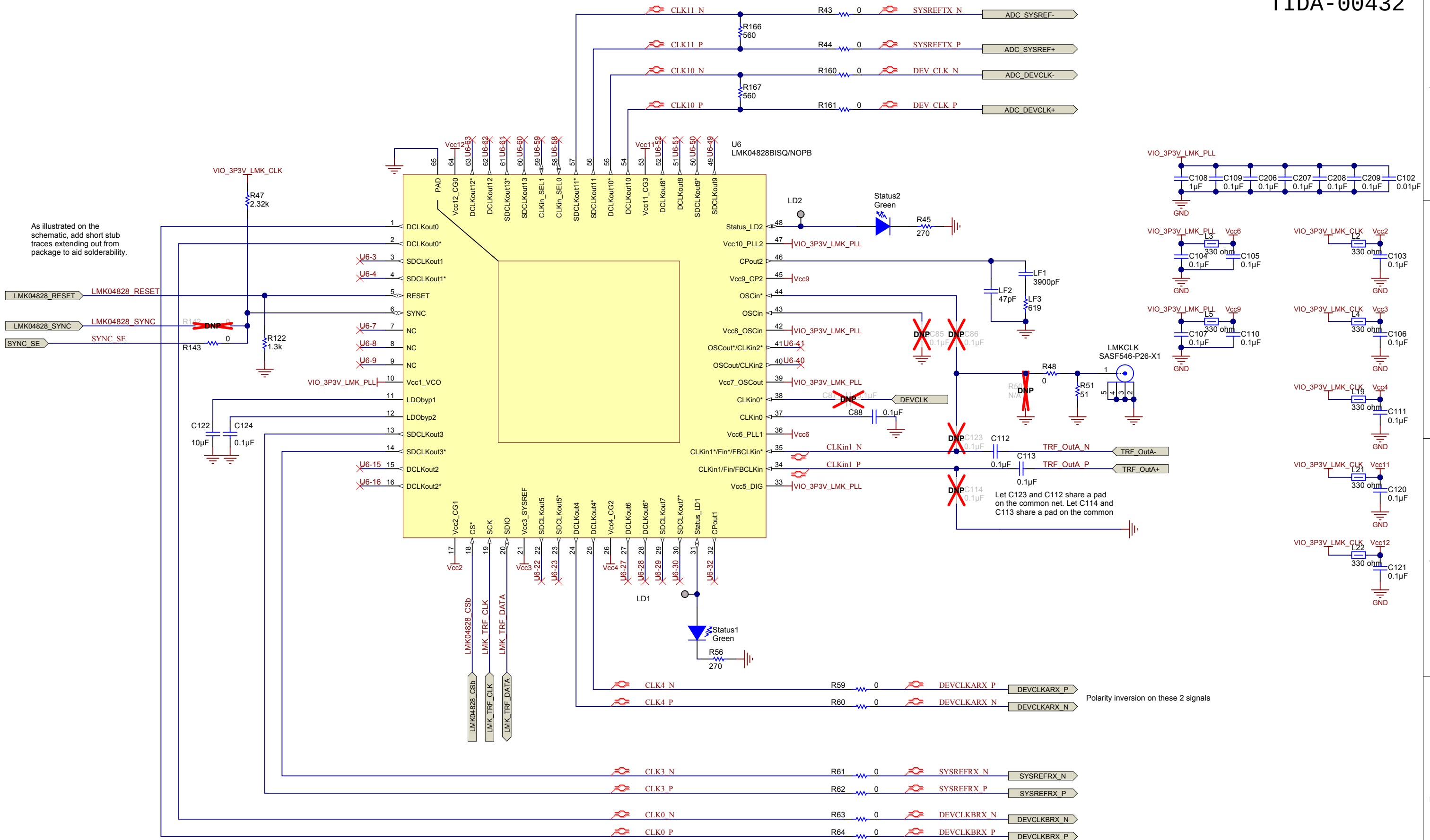


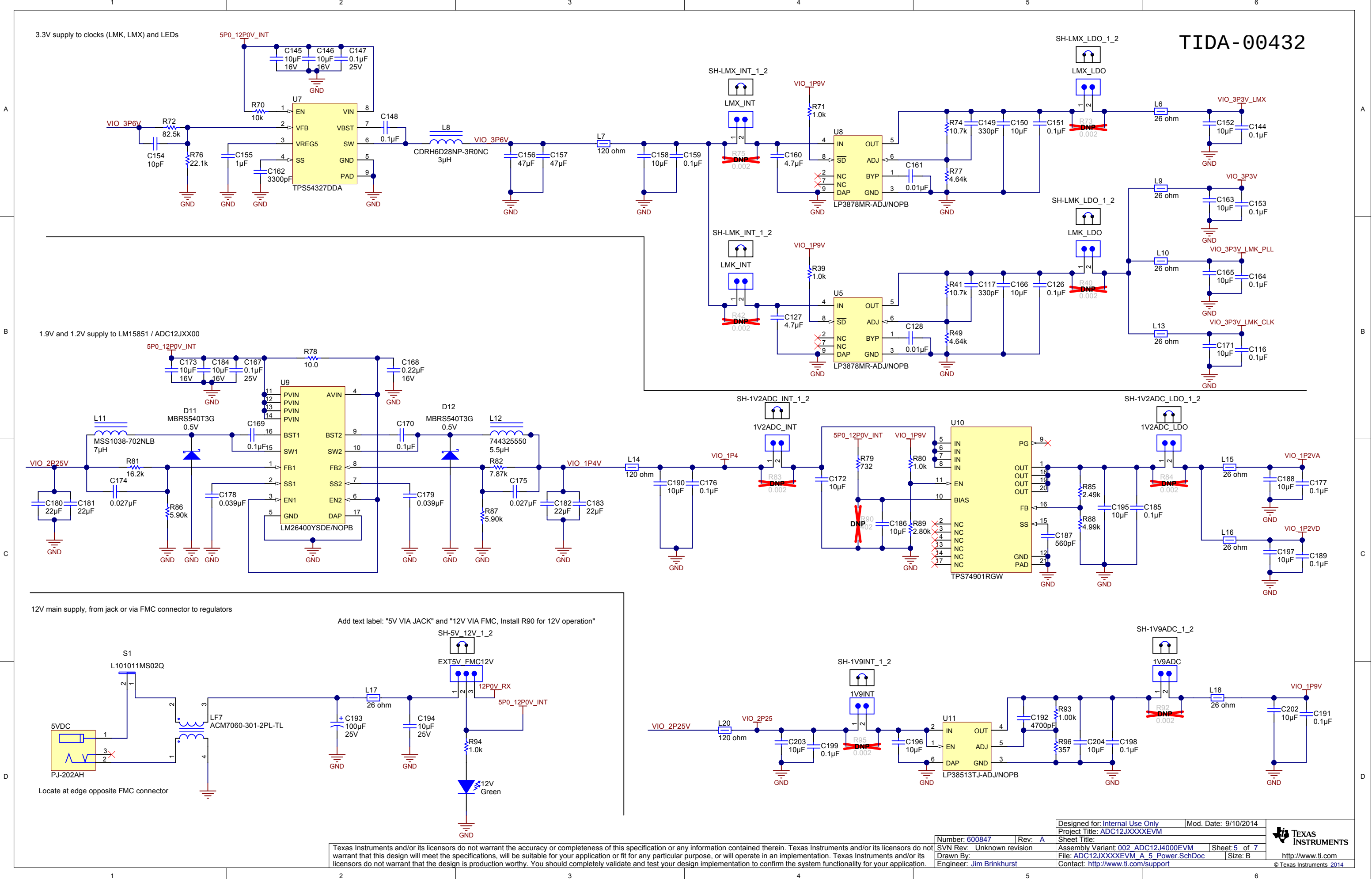
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Designed for: Internal Use Only		Mod. Date: 9/10/2014	
Project Title: ADC12JXXXXEVM		Rev: A	
Sheet Title: TRF3765		Number: 600847	
Assembly Variant: 002_ADC12J4000EVM		Rev: A	
File: ADC12JXXXXEVM_A_3_TRF3765.SchDoc		Sheet: 3 of 7	
Contact: http://www.ti.com/support		Size: B	
Drawn By: Not shown in title block		Engineer: Jim Brinkhurst	
SVN Rev: Unknown revision		Texas Instruments	
		http://www.ti.com	
		© Texas Instruments 2014	



As illustrated on the schematic, add short stub traces extending out from package to aid solderability.



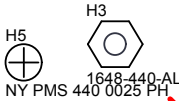
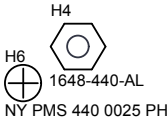




PCB
ESD LOGO
ESD Susceptible

PCB
LOGO
Texas Instruments

PCB Number: 600847
PCB Rev: A

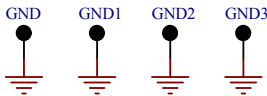


H9
MECH
FMC - FMC Screw
PMSSS 256 0075 PH

H10
MECH
FMC - FMC Nut

H11
MECH
FMC - FMC Screw
PMSSS 256 0075 PH

H12
MECH
FMC - FMC Nut



Place at least two of the GND test points in the power section.

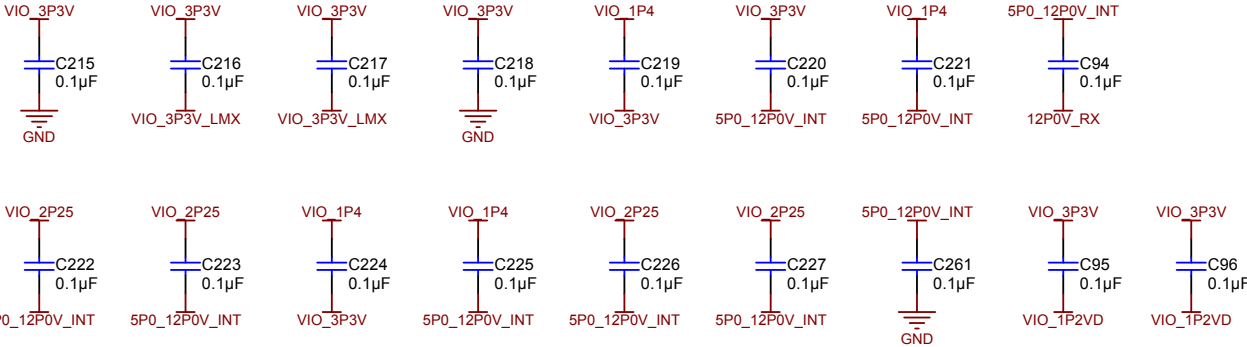
LBL1
PCB Label
Size: 0.65" x 0.20 "

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.



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